



TESSERA 3.0-022

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of: :
Karavakis, et al. : Group Art Unit: 2203 ✓
Serial No. 08/246,113 :
Filed: May 19, 1994 :
For: METHOD OF ENCAPSULATING :
DIE AND CHIP CARRIER :
Dated: September 15, 1994

Hon. Commissioner of Patents
and Trademarks
Washington, D.C. 20231

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GROUP 2200

INFORMATION DISCLOSURE STATEMENT

Sir:

It is respectfully requested that the references listed on the enclosed Form PTO-1449 be made of record and considered with respect to the above-referenced U.S. Patent application. A copy of each reference is enclosed. Submission of the present Information Disclosure Statement should not be taken as an admission that the cited references are legally available prior art or that the same are pertinent or material.

Respectfully submitted,

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I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner of Patents and Trademarks, Washington, D.C. 20231 on
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